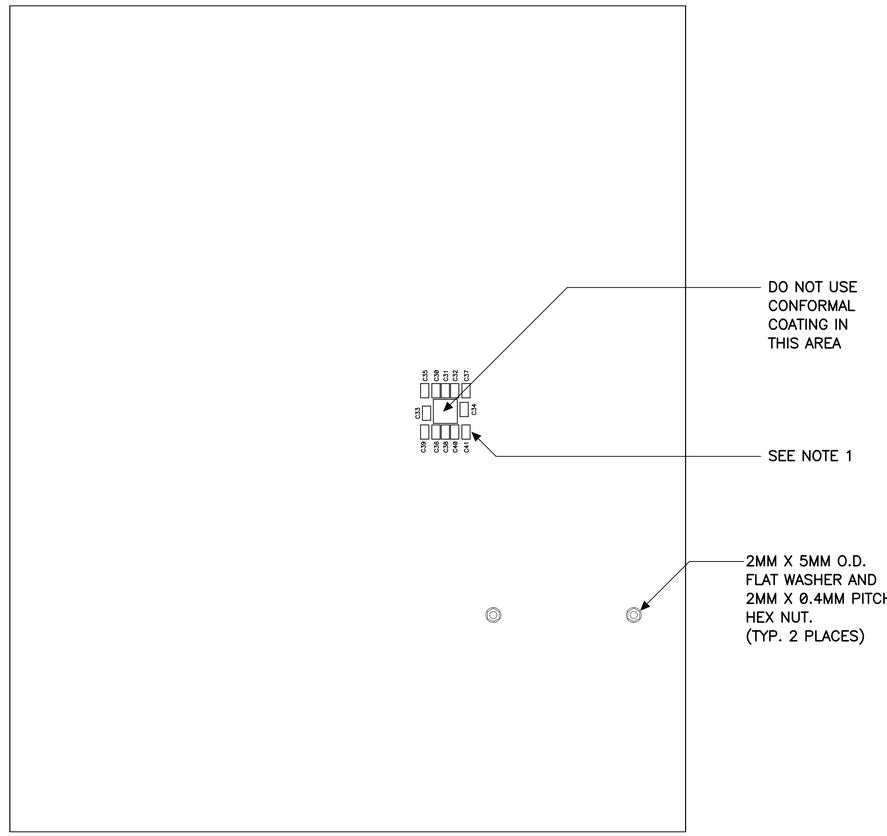
NOTES:

1. CAPACITORS C30 THRU C41 SHALL BE HAND PLACED AND HAND SOLDERED PER ESG STANDARD E–9, AFTER THE TOP SIDE IS ASSEMBLED, BUT BEFORE CONFORMAL COATING.

2. CIRCUIT BOARDS SHALL BE ASSEMBLED AND CLEANED PER ESG STANDARD E–9.

3. COVER BOTTOM SIDE OF ASSEMBLED BOARD (BEFORE TESTING AND BURN–IN) ALL OVER, PER ESG STANDARD E–9, WITH CONFORMAL COATING SPECIFIED IN BILL OF MATERIAL.

4. SEE SHEET 7 FOR TOP SIDE ASSEMBLY NOTES.



ASSEMBLY DRAWING – BOTTOM SIDE

REV LEV	DATE	REVISION RECORD	CHG. NO.	DR.	CK.
–		NEW.	NOT REL'D	KAW	BAS
A	04/03/03	SEE OTHER SHEETS.	0702–0007	KAW	BAS
B	10/17/03	SEE SHEET 7.	0703–3024	KAW	BAS

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YORK INTERNATIONAL CORPORATION
YORK, PA 17405

DIMENSIONS ARE IN INCHES
DO NOT SCALE
TOLERANCES PER ENG. STD. M–282
WELDING PER ENG. STD. M–30
REF. DWG.

CONTROL, OPTIVIEW MICROPROCESSOR BOARD (REF. DWG.)

MATERIAL
PART NO. ____ ENG. STD. E–355
TYPE ____
CUT SIZE ____

NAME	DATE
DR. K. WERTMAN	05–15–02
APPR. B. SMITH	06–15–02
SCALE: N.T.S.	

SIZE D | CAGE NO 66935 | DRAWING NUMBER 031–02430–999

WT. = LBS. | ORIG. NO. | SHEET 8 OF 9